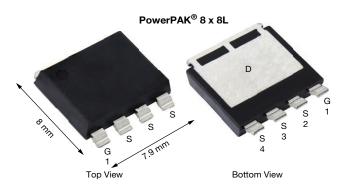
# SQJQ150E

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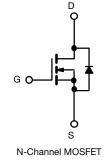
# Automotive N-Channel 40 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY	
V <sub>DS</sub> (V)	40
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0019
I <sub>D</sub> (A)	233
Configuration	Single
Package	PowerPAK 8 x 8L

#### FEATURES

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>q</sub> and UIS tested
- Thin 1.6 mm package
- Very low thermal resistance
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ABSOLUTE MAXIMUM RATIN	<b>GS</b> (T <sub>C</sub> = 25 °C, unless	otherwise noted	)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	40	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
Continuous drain current	T <sub>C</sub> = 25 °C	1	233		
Continuous drain current	T <sub>C</sub> = 125 °C	I <sub>D</sub>	134		
Continuous source current (diode conduct	ion)	I <sub>S</sub>	170	А	
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	930			
Single pulse avalanche current		I <sub>AS</sub>	38		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	72	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C	D	187	W	
waximum power dissipation	T <sub>C</sub> = 125 °C	P <sub>D</sub>	62	vv	
Operating junction and storage temperature	re range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temper	ature) <sup>c</sup>		260	U	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount <sup>b</sup>	R <sub>thJA</sub>	44	°C/W
Junction-to-case (drain)		R <sub>thJC</sub>	0.8	C/ W

#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. When mounted on 1" square PCB (FR4 material)
- c. See solder profile (<u>www.vishay.com/doc?73257</u>). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection



COMPLIANT

HALOGEN

FREE

SQJQ150E



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = 250 \ \mu A$		40	-	-	v	
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2	2.8	3.5		
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	= 0 V, V <sub>GS</sub> = ± 20 V	-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V	-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 40 V, T <sub>J</sub> = 175 °C	-	-	150	1	
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	100	-	-	А	
Drain-source on-state resistance <sup>a</sup>		$V_{GS} = 10 V$	I <sub>D</sub> = 20 A	-	0.0015	0.0019	1	
	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C	-	-	0.003	Ω	
		$V_{GS} = 10 V$	I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C	-	-	0.0035		
Forward transconductance b	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 30 A	-	120	-	S	
Dynamic <sup>b</sup>		<u>.</u>						
Input capacitance	C <sub>iss</sub>			-	3316	4643		
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$	$V_{DS} = 25 V$ , f = 1 MHz	-	1137	1592	pF	
Reverse transfer capacitance	C <sub>rss</sub>	-		-	134	188	1	
Total gate charge <sup>c</sup>	Qg			-	61	92		
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 10 V$	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	17	-	nC	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>	-		-	17	-	1	
Gate resistance	R <sub>g</sub>		f = 1 MHz	0.8	1.7	2.6	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>			-	17	27		
Rise time <sup>c</sup>	t <sub>r</sub>	V <sub>DD</sub> =	= 20 V, $R_L = 1.0 \Omega$ ,	-	19	29		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 20$ Å, $V_{GEN} = 10$ V, $R_g = 1$ $\Omega$		-	30	45	ns	
Fall time <sup>c</sup>	t <sub>f</sub>	-			10	15	1	
Source-Drain Diode Ratings and Cha	racteristics <sup>b</sup>							
Reverse recovery time	t <sub>rr</sub>		00.1/1 45.5	-	40	80	ns	
Reverse recovery charge	Q <sub>rr</sub>		= 32 V, I <sub>FM</sub> = 15 A, //dt = 100 A/µs	-	34	68	nC	
Reverse recovery current	I <sub>RM</sub>		/αι = 100 //μ3	-	-1.5	-	Α	
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	660	А	
	V <sub>SD</sub>	$I_{\rm F} = 50 \text{ A}, V_{\rm GS} = 0$			0.8	1.1	V	

#### Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

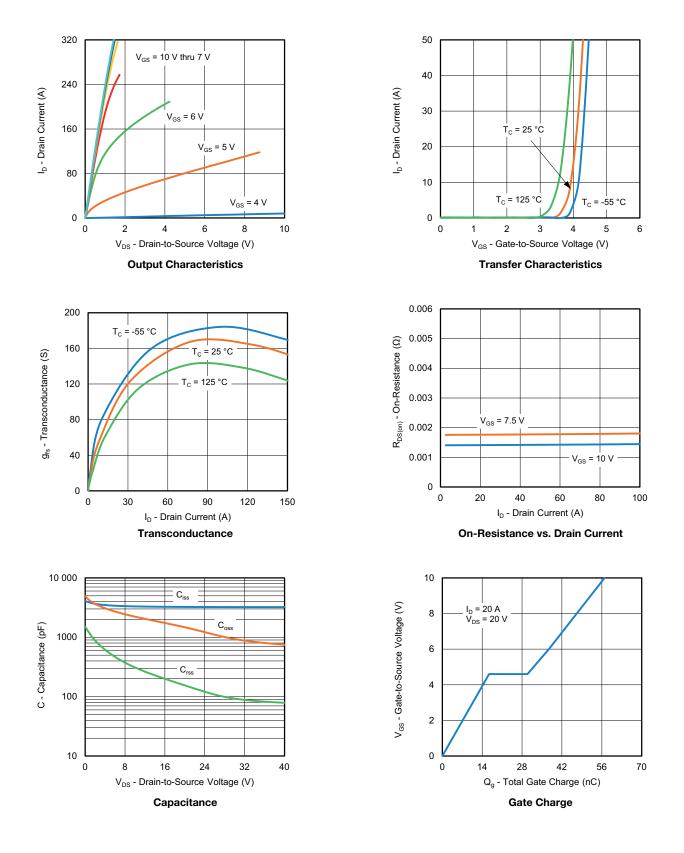
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



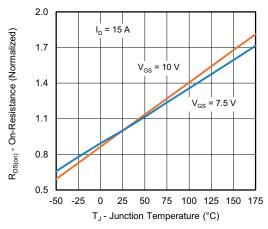
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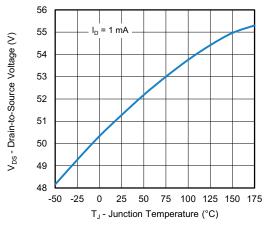


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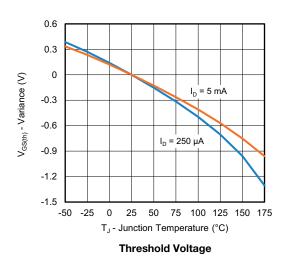
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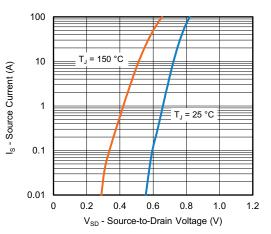


On-Resistance vs. Junction Temperature

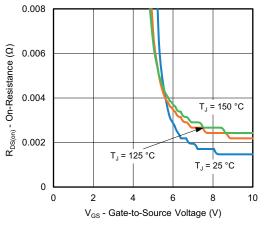


Drain Source Breakdown vs. Junction Temperature

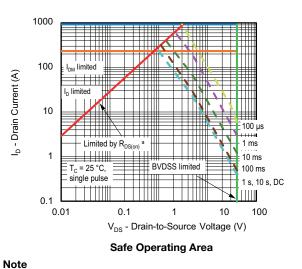




Source Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



a. V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

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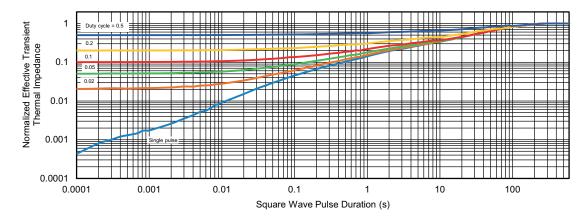
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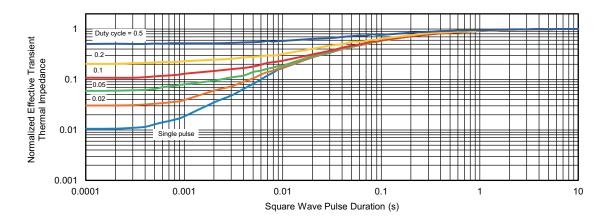
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### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



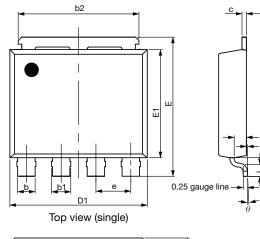
Normalized Thermal Transient Impedance, Junction-to-Case

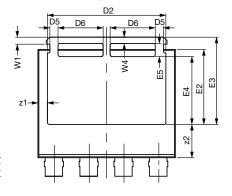
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# PowerPAK<sup>®</sup> 8 x 8L BWL Case Outline 2

A1





Bottom view (single)

1					1	- 4	L
F	-				⇒	∢	
							1
~			 L	 			-

DIM.						
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	1.50	1.60	1.70	0.059	0.063	0.067
A1	0.00	-	0.127	0.000	-	0.005
A2	0.655	0.705	0.755	0.026	0.028	0.030
b	0.92	1.00	1.08	0.036	0.039	0.043
b1	1.02	1.10	1.18	0.040	0.043	0.046
b2	6.84	6.94	7.04	0.269	0.273	0.277
С	0.20	0.25	0.30	0.008	0.010	0.012
D1	7.80	7.90	8.00	0.307	0.311	0.315
D2	6.70	6.80	6.90	0.264	0.268	0.272
D5	0.37	0.47	0.57	0.015	0.019	0.022
D6	2.49	2.59	2.69	0.098	0.102	0.106
e 1.97		2.00	2.03	0.078	0.079	0.080
E 7.90		8.00	8.10	0.311	0.315	0.319
E1 6.12		6.22	6.32	0.241	0.245	0.249
E2	4.21	4.31	4.41	0.166	0.170	0.174
E3 4.92		5.02	5.12	0.194	0.198	0.202
E4 3.80		3.90	4.00	0.150	0.154	0.157
E5	0.65	0.75	0.85	0.026	0.030	0.033
L	0.61	0.68	0.75	0.024	0.027	0.030
L1	1.00	1.07	1.15	0.039	0.042	0.045
W1	0.30	0.40	0.50	0.012	0.016	0.020
W4	0.32	0.37	0.42	0.013	0.015	0.017
z1	0.45	0.55	0.65	0.018	0.022	0.026
z2	1.81	1.91	2.01	0.071	0.075	0.079
θ	0°	-	5°	0°	-	5°

#### Note

Millimeter will govern

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